

# Brian Benchoff | Prototype Engineer

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## Experience

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### Vocational

#### Span.io

San Francisco

*Prototype Engineer*

2022-Present

Developed novel data acquisition unit for isolated thermocouple measurement using RP2040 microcontroller, C, Modbus, and Ethernet interfaces. Created comprehensive data acquisition system with Flask/React web interface and Python backend supporting multiple hardware interfaces (NIDAQ, ADAM, LabJack). Designed and fabricated specialized test rigs and prototypes using KiCad PCB design and 3D printing. Built test fixtures and cable harnesses for UL AFCI/GFCI compliance testing. Implemented V2G (Vehicle-to-Grid) home backup power solution prototype utilizing Nissan Leaf with CHAdeMO interface.

#### Self-Employed

San Francisco

*Embedded Engineer, Product Designer*

2016-2022

Designed, built, and sold consumer electronics. This included 3D CAD Fusion360, AutoCAD, PCB design Eagle, KiCAD, Design for Manufacturability and Design for Assembly. Closely integrated with PCB assembly, up to and including running pick and place machines. Fabrication of 3D printed and injection molded parts in plastic and silicone. Designed, marketed, and sold several successful products.

#### Supplyframe

Pasadena, CA

*Content Specialist*

2018-Present

Produced electronic design and engineering content, engaged with engineers regarding new products. Responsible for hardware projects, PCB & firmware design. 3D modeling, injection molded and 3D printed plastic and silicone.

#### Hackaday

Pasadena, CA

*Editor*

2011-2018

Wrote, edited, produced content for weblog Hackaday. Designed hardware products and projects.

## Skills

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Languages: C, C++, Python,  $\text{\LaTeX}$ , SQL

Graphic: Adobe Photoshop, Illustrator, Premiere

**Mechanical CAD:** Fusion360, AutoCAD, OpenSCAD

**Electronic CAD:** Altium, Eagle, KiCAD

**Embedded:** I2C, SPI, Serial, Parallel interfaces, USB, USB-C, HDMI, PCIe, eMMC

**Embedded Linux:** Buildroot, Yocto

**Platforms:** x86, 8085, AVR, ARM Cortex-M (M0 & M4), RP2040/2350 PIO, Linux SoCs (Microchip, Allwinner)

**Misc:** Microsoft Office, 3D Printing, Rapid Prototyping, Industrial Design

**PCB:** BGA, Down to 2/2mil trace/space, 010005 components

**Mechanical:** Injection molding in plastic and silicone, machining